



JMSL0307AG

## 30V 3.8mΩ N-Ch Power MOSFET

### Features

- Ultra-low  $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100%  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

### Product Summary

| Parameter                            | Value | Unit |
|--------------------------------------|-------|------|
| $V_{DS}$                             | 30    | V    |
| $V_{GS(th)}_{Typ}$                   | 1.7   | V    |
| $I_D (@ V_{GS} = 10V)^{(1)}$         | 65    | A    |
| $R_{DS(ON)}_{Typ} (@ V_{GS} = 10V)$  | 3.8   | mΩ   |
| $R_{DS(ON)}_{Typ} (@ V_{GS} = 4.5V)$ | 5.8   | mΩ   |

### Applications

- Power Management in Computing, CE, IE 4.0, Communications
- Current Switching in DC/DC & AC/DC Sub-systems
- Motor Driving, Quick/Wireless Charging

PDFN5x6-8L

Top View

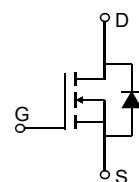
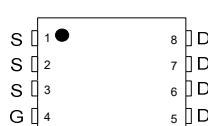


Bottom View



Pin Configuration

Top View

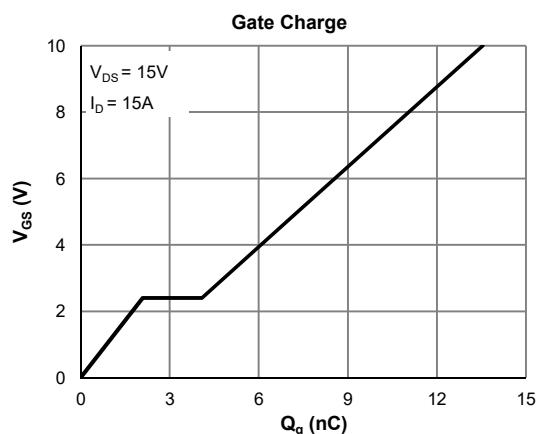
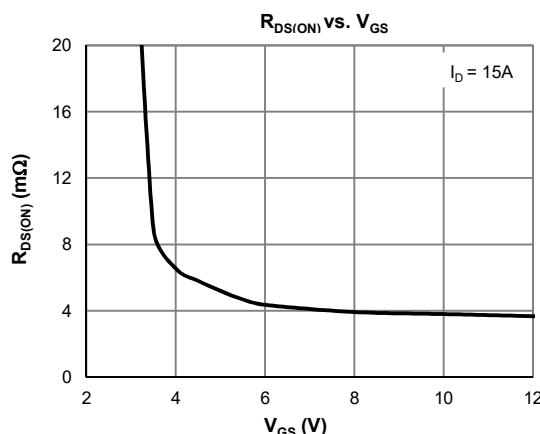


### Ordering Information

| Device        | Package    | # of Pins | Marking | MSL | $T_J$ (°C) | Media        | Quantity (pcs) |
|---------------|------------|-----------|---------|-----|------------|--------------|----------------|
| JMSL0307AG-13 | PDFN5x6-8L | 8         | SL0307A | 1   | -55 to 150 | 13-inch Reel | 5000           |

### Absolute Maximum Ratings (@ $T_A = 25^\circ C$ unless otherwise specified)

| Parameter  | Symbol         | Value      | Unit |
|--|----------------|------------|------|
| Drain-to-Source Voltage                                | $V_{DS}$       | 30         | V    |
| Gate-to-Source Voltage                                 | $V_{GS}$       | $\pm 20$   | V    |
| Continuous Drain Current<br>( $T_C = 25^\circ C$ )     | $I_D$          | 65         | A    |
| $T_C = 100^\circ C$                                    | $I_D$          | 41         |      |
| Pulsed Drain Current <sup>(2)</sup>                    | $I_{DM}$       | 190        | A    |
| Avalanche Current <sup>(3)</sup>                       | $I_{AS}$       | 20         | A    |
| Avalanche Energy <sup>(3)</sup>                        | $E_{AS}$       | 20         | mJ   |
| Power Dissipation <sup>(4)</sup><br>$T_C = 25^\circ C$ | $P_D$          | 31         | W    |
| $T_C = 100^\circ C$                                    | $P_D$          | 12.5       |      |
| Junction & Storage Temperature Range                   | $T_J, T_{STG}$ | -55 to 150 | °C   |



**Electrical Characteristics (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)**

| Parameter                                     | Symbol                      | Conditions  | Min. | Typ.       | Max.       | Unit             |
|---|-----------------------------|---|------|------------|------------|------------------|
| <b>STATIC PARAMETERS</b>                      |                             |   |      |            |            |                  |
| Drain-Source Breakdown Voltage                | $V_{(\text{BR})\text{DSS}}$ | $I_D = 1\text{mA}, V_{GS} = 0\text{V}$  | 30   |            |            | V                |
| Zero Gate Voltage Drain Current               | $I_{\text{DSS}}$            | $V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$<br>$T_J = 55^\circ\text{C}$                   |      |            | 1.0<br>5.0 | $\mu\text{A}$    |
| Gate-Body Leakage Current                     | $I_{GSS}$                   | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$   |      |            | $\pm 100$  | nA               |
| Gate Threshold Voltage                        | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$   | 1.2  | 1.7        | 2.5        | V                |
| Static Drain-Source ON-Resistance             | $R_{DS(\text{ON})}$         | $V_{GS} = 10\text{V}, I_D = 15\text{A}$<br>$V_{GS} = 4.5\text{V}, I_D = 10\text{A}$     |      | 3.8<br>5.8 | 4.8<br>7.5 | $\text{m}\Omega$ |
| Forward Transconductance                      | $g_{FS}$                    | $V_{DS} = 5\text{V}, I_D = 15\text{A}$  |      | 198        |            | S                |
| Diode Forward Voltage                         | $V_{SD}$                    | $I_S = 1\text{A}, V_{GS} = 0\text{V}$   |      | 0.65       | 1.0        | V                |
| Diode Continuous Current                      | $I_S$                       | $T_C = 25^\circ\text{C}$  |      |            | 31         | A                |
| <b>DYNAMIC PARAMETERS (5)</b>                 |                             |   |      |            |            |                  |
| Input Capacitance                             | $C_{iss}$                   | $V_{GS} = 0\text{V}, V_{DS} = 15\text{V}, f = 1\text{MHz}$                              |      | 866        |            | pF               |
| Output Capacitance                            | $C_{oss}$                   |   |      | 739        |            | pF               |
| Reverse Transfer Capacitance                  | $C_{rss}$                   |   |      | 54         |            | pF               |
| Gate Resistance                               | $R_g$                       | $V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$                               |      | 2.0        |            | $\Omega$         |
| <b>SWITCHING PARAMETERS (5)</b>               |                             |   |      |            |            |                  |
| Total Gate Charge (@ $V_{GS} = 10\text{V}$ )  | $Q_g$                       | $V_{GS} = 0 \text{ to } 10\text{V}$<br>$V_{DS} = 15\text{V}, I_D = 15\text{A}$          |      | 13.5       |            | nC               |
| Total Gate Charge (@ $V_{GS} = 4.5\text{V}$ ) | $Q_g$                       |   |      | 6.7        |            | nC               |
| Gate Source Charge                            | $Q_{gs}$                    |   |      | 2.1        |            | nC               |
| Gate Drain Charge                             | $Q_{gd}$                    |   |      | 2.0        |            | nC               |
| Turn-On DelayTime                             | $t_{D(\text{on})}$          | $V_{GS} = 10\text{V}, V_{DS} = 15\text{V}$<br>$R_L = 1\Omega, R_{\text{GEN}} = 6\Omega$ |      | 2.4        |            | ns               |
| Turn-On Rise Time                             | $t_r$                       |   |      | 2.5        |            | ns               |
| Turn-Off DelayTime                            | $t_{D(\text{off})}$         |   |      | 12.7       |            | ns               |
| Turn-Off Fall Time                            | $t_f$                       |   |      | 6.9        |            | ns               |
| Body Diode Reverse Recovery Time              | $t_{rr}$                    | $I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$                                   |      | 26         |            | ns               |
| Body Diode Reverse Recovery Charge            | $Q_{rr}$                    | $I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$                                   |      | 10.6       |            | nC               |

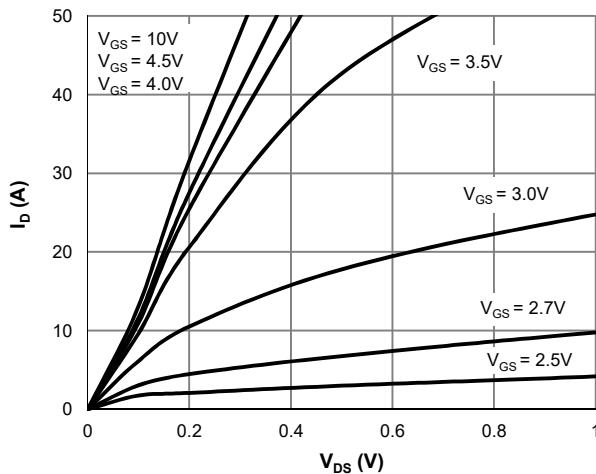
**Thermal Performance**

| Parameter                               | Symbol          | Typ. | Max. | Unit               |
|---|-----------------|------|------|--------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 45   | 55   | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 3.0  | 4.0  | $^\circ\text{C/W}$ |

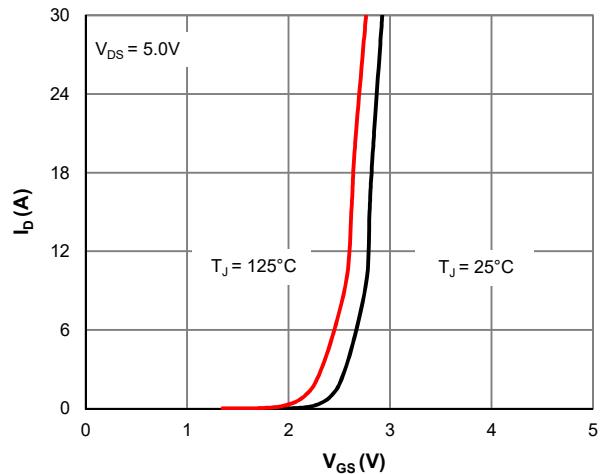
**Notes:**

1. Computed continuous current assumes the condition of  $T_{J_{\text{Max}}}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J_{\text{Max}}} = 150^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [ $L = 100\mu\text{H}, V_{GS} = 10\text{V}, V_{DS} = 15\text{V}$ ] while its value is limited by  $T_{J_{\text{Max}}} = 150^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J_{\text{Max}}} = 150^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.

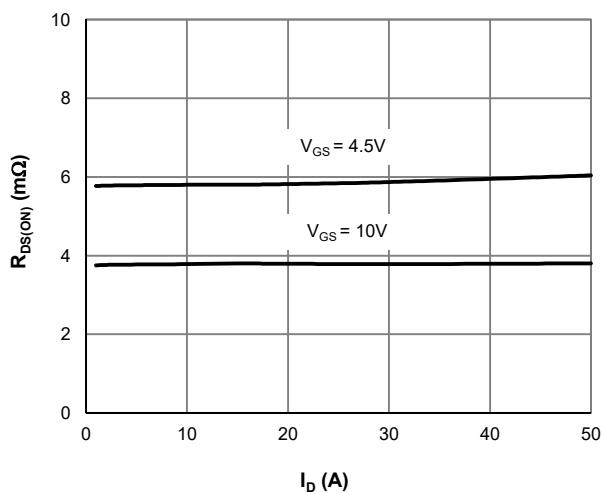
### Typical Electrical & Thermal Characteristics



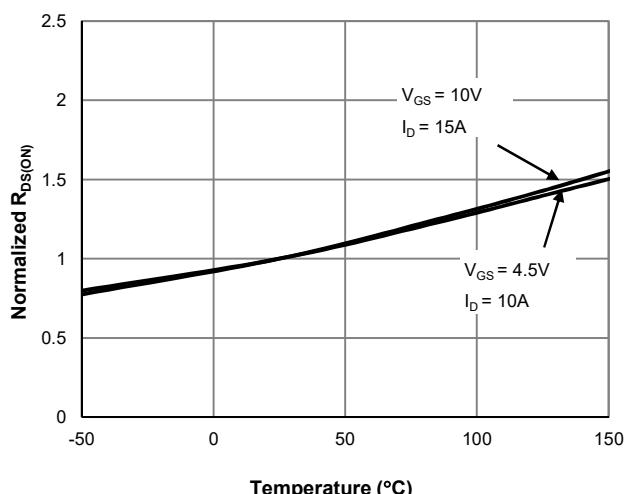
**Figure 1: Saturation Characteristics**



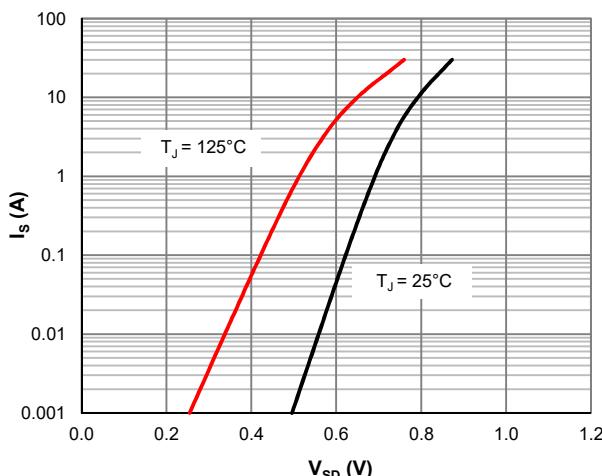
**Figure 2: Transfer Characteristics**



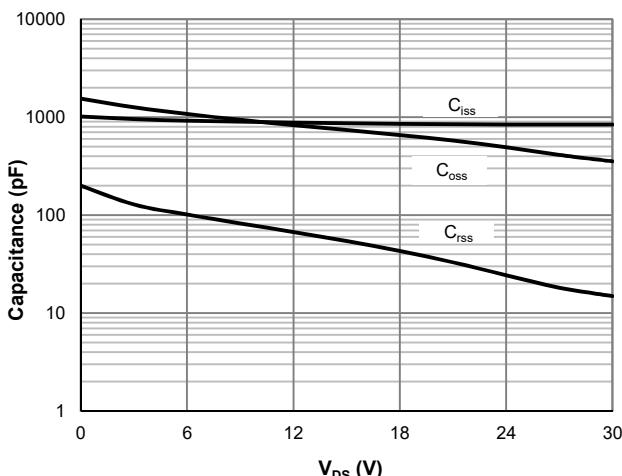
**Figure 3:  $R_{DS(ON)}$  vs. Drain Current**



**Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature**



**Figure 5: Body-Diode Characteristics**



**Figure 6: Capacitance Characteristics**

### Typical Electrical & Thermal Characteristics

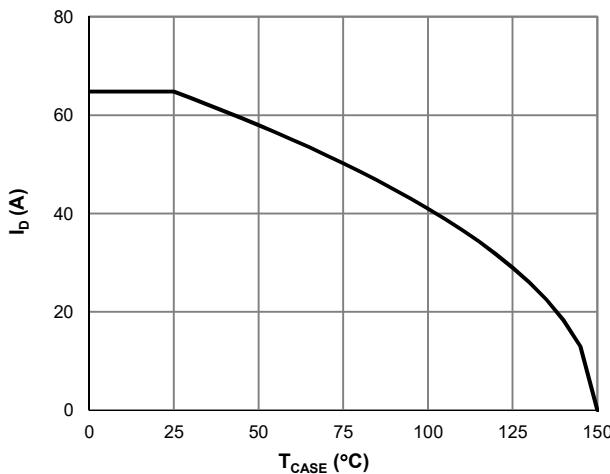


Figure 7: Current De-rating

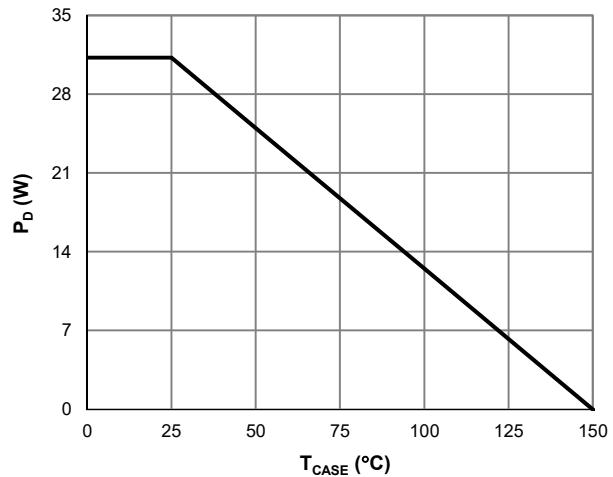


Figure 8: Power De-rating

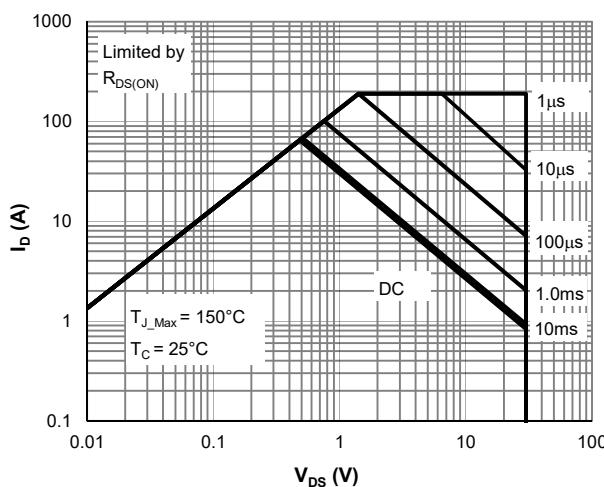


Figure 9: Maximum Safe Operating Area

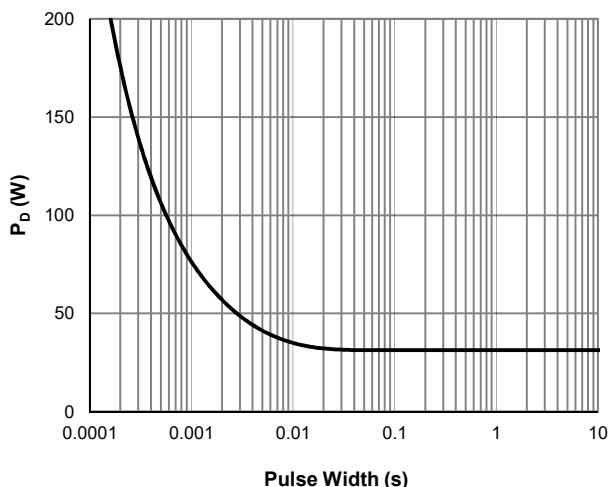


Figure 10: Single Pulse Power Rating, Junction-to-Case

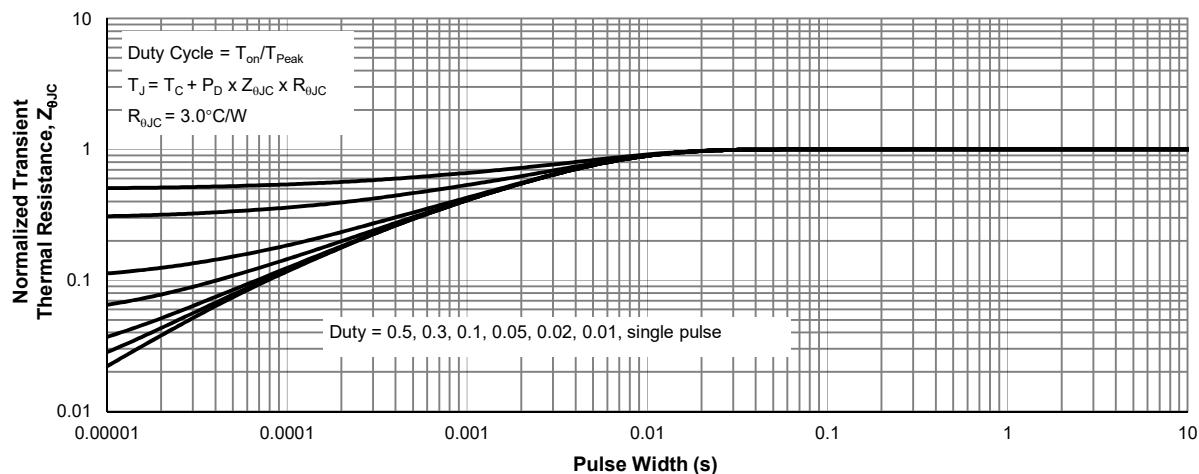
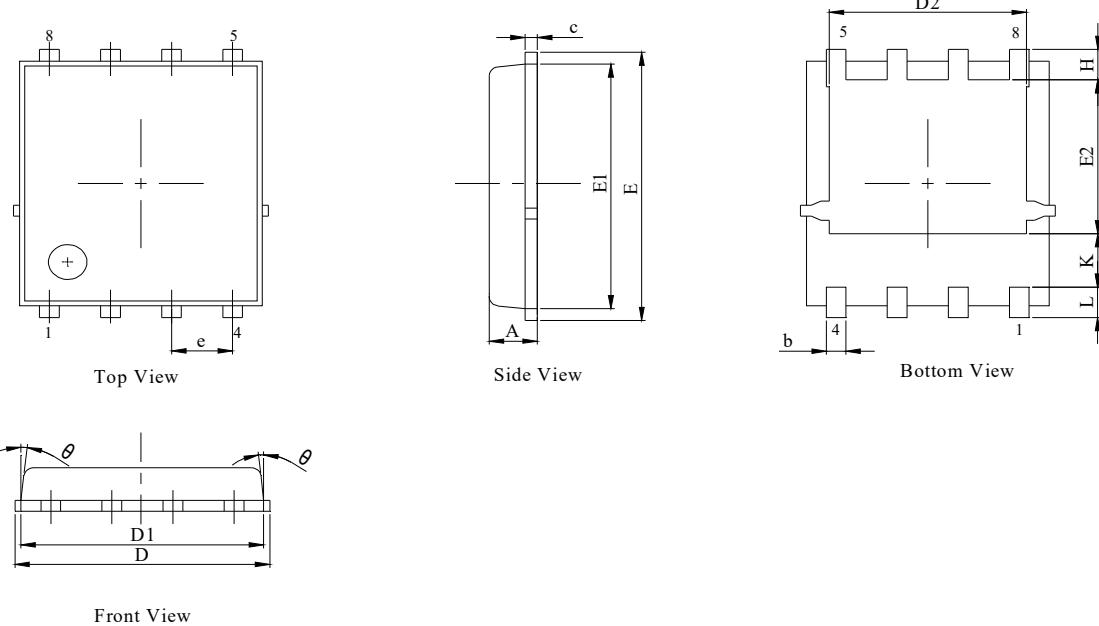
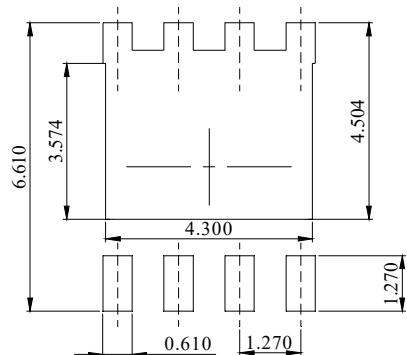


Figure 11: Normalized Maximum Transient Thermal Impedance

**PDFN5x6-8L Package Information**
**Package Outline**

**NOTES:**

1. Dimension and tolerance per ASME Y14.5M, 1994.
2. All dimensions in millimeter (angle in degree).
3. Dimensions D1 and E1 do not include mold flash protrusions or gate burrs.

| DIM.     | MILLIMETER |          |      |
|----------|------------|----------|------|
|          | MIN.       | NOM.     | MAX. |
| A        | 0.90       | 1.00     | 1.10 |
| b        | 0.31       | 0.41     | 0.51 |
| c        | 0.20       | 0.25     | 0.30 |
| D        | 5.00       | 5.20     | 5.40 |
| D1       | 4.95       | 5.05     | 5.15 |
| D2       | 4.00       | 4.10     | 4.20 |
| E        | 6.05       | 6.15     | 6.25 |
| E1       | 5.50       | 5.60     | 5.70 |
| E2       | 3.42       | 3.53     | 3.63 |
| e        |            | 1.27BSC  |      |
| H        | 0.60       | 0.70     | 0.80 |
| L        | 0.50       | 0.70     | 0.80 |
| K        |            | 1.23 REF |      |
| $\theta$ | -          | -        | 10°  |

**Recommended Soldering Footprint**


DIMENSIONS: MILLIMETERS

单击下面可查看定价，库存，交付和生命周期等信息

[>>JJW\(捷捷微\)](#)